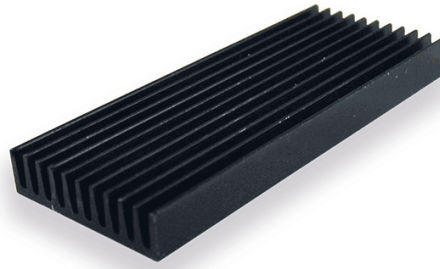


Product features PR

8/47/SE

Semiconductor casing:	DIL
Semiconductor mounted by:	Bonding
Heat sink mounted by:	Adhesive Bounding
Finish	Black Anodised
Material	AlMgSi0,5
Width [mm]:	18.9
Height [mm]:	4.8
Length [mm]:	47.0
Standardlänge [mm]:	47.0
Min. thermal resistance [K/W]:	9.0



Further information

- Extruded heatsinks especially for IC's in DUAL IN LINE case. -
- Mounting by single component thermal conductive adhesive -
- Standard length: - 6,3 mm for 14/16 pins - 33 mm for 24 pins -
- 37 mm for 28 pins - 47 mm for 35 pins - 51 mm for 40 pins -
- Other lengths and machining on request.

